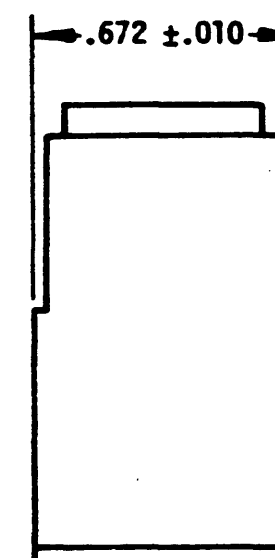
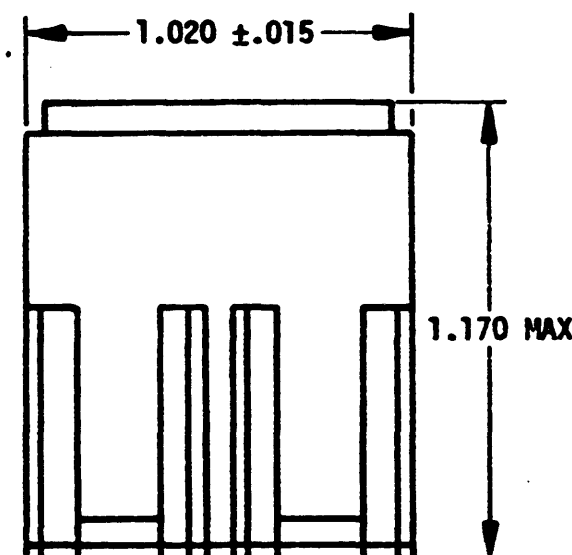
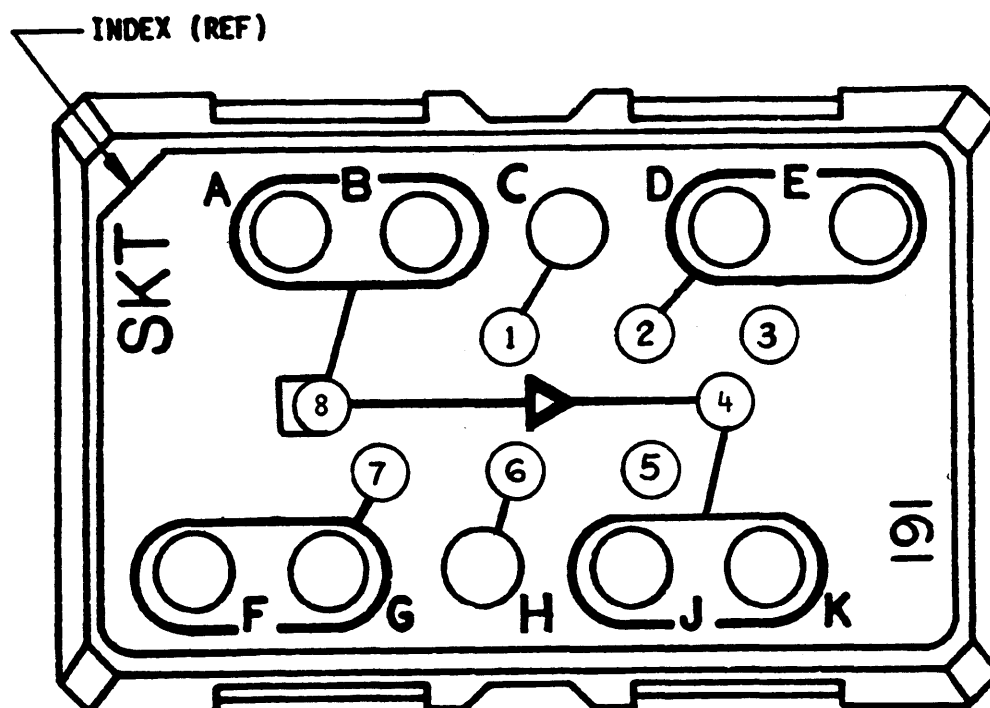


B	CTJ420E191-513	REVISIONS		
		SYM	DESCRIPTION	DATE
		B	REVISED PER E.O. A13163	8-20-92



10. COMPONENT: (1) HARRIS HA2-5002/883 (METAL CAN)
HIGH OUTPUT CURRENT BUFFER.
9. SOCKET CONTACTS MEET MIL-C-39029/22-192 REQUIREMENTS.
8. JUNCTION ELECTRONIC COMPONENT TEMPERATURE RANGE: -67°F TO 257°F
(-55°C to 125°C).
7. MATERIALS AND FINISHES
HOUSING - THERMO PLASTIC
GROMMET - METHYL VINYL FLUORO SILICONE BLEND ELASTOMER.
PIN CONTACTS - COPPER ALLOY PLATED GOLD
6. CONTACT TOOL NO. M15570-20 IS REQUIRED.
5. SEE ENVELOPE DRAWING NO CTJ-3*-** FOR SUITABLE RAIL ASSEMBLIES.
4. FOR CONTACT DATA SEE ENVELOPE DRAWING 1625-1-0000.
3. CTJ420E191-513
MODIFICATION
CIRCUIT ARRANGEMENT
BASIC IDENTIFIER

NOTE:

2. CIRCUIT IDENTIFICATION IS SHOWN FOR REFERENCE ONLY AND
MAY NOT BE IN TRUE POSITION.
1. DIMENSIONS ARE IN INCHES UNLESS OTHERWISE SPECIFIED.

SIGNATURE & DATE		JUNCTION ASSEMBLY ELECTRONIC COMPONENT SIZE 12 SIZE 20 CONTACTS 191 ARRANGEMENT ENVELOPE	CP	MATL CODE
DR	Ron von Heeringen 11-27-91		The Deutsch Company ELECTRONIC COMPONENTS DIVISION Municipal Airport Banning, California	
CHK	Jo Russell 12-16-91		B CTJ420E191-513	
PE	Ron von Heeringen 11-27-91		DWG SIZE	
APPD			CODE 11139	
SCALE NONE		WT	SHEET / OF /	